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April 2015

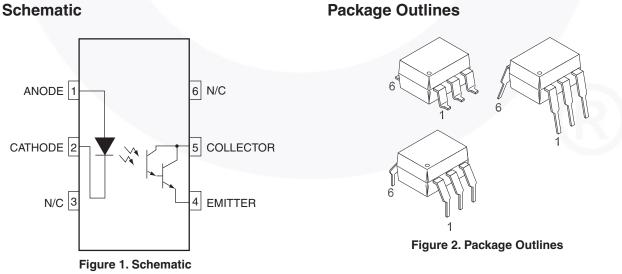
MOC8021M, MOC8050M 6-Pin DIP Photodarlington Optocoupler (No Base Connection)

Features

- High BV_{CEO}:
 - Minimum 50 V (MOC8021M)
 - Minimum 80 V (MOC8050M)
- High Current Transfer Ratio:
 - Minimum 1000% (MOC8021M)
 - Minimum 500% (MOC8050M)
- No Base Connection for Improved Noise Immunity
- Safety and Regulatory Approvals:
 - UL1577, 4,170 VAC_{RMS} for 1 Minute
 - DIN-EN/IEC60747-5-5, 850 V Peak Working Insulation Voltage

Applications

- Appliances, Measuring Instruments
- I/O Interface for Computers
- Programmable Controllers
- Portable Electronics
- Interfacing and Coupling Systems of Different Potentials and Impedance
- Solid State Relays



Description

The MOC8021M and MOC8050M are photodarlingtontype optically coupled optocouplers. The devices have a gallium arsenide infrared emitting diode coupled with a silicon darlington phototransistor. MOC8021M, MOC8050M — 6-Pin DIP Photodarlington Optocoupler (No Base Connection)

Safety and Insulation Ratings

As per DIN EN/IEC 60747-5-5, this optocoupler is suitable for "safe electrical insulation" only within the safety limit data. Compliance with the safety ratings shall be ensured by means of protective circuits.

Parameter	Characteristics	
Installation Classifications per DIN VDE	< 150 V _{RMS}	I–IV
0110/1.89 Table 1, For Rated Mains Voltage	< 300 V _{RMS}	I–IV
Climatic Classification	55/100/21	
Pollution Degree (DIN VDE 0110/1.89)		2
Comparative Tracking Index		175

Symbol	Parameter	Value	Unit	
$V_{PR} \begin{tabular}{lllllllllllllllllllllllllllllllllll$		1360	V _{peak}	
		1594	V _{peak}	
V _{IORM}	Maximum Working Insulation Voltage	850	V _{peak}	
V _{IOTM}	Highest Allowable Over-Voltage	6000	V _{peak}	
	External Creepage	≥ 7	mm	
	External Clearance	≥ 7	mm	
	External Clearance (for Option TV, 0.4" Lead Spacing)	≥ 10	mm	
DTI	Distance Through Insulation (Insulation Thickness)	≥ 0.5	mm	
Τ _S	Case Temperature ⁽¹⁾	175	°C	
I _{S,INPUT}	Input Current ⁽¹⁾	350	mA	
P _{S,OUTPUT}	Output Power ⁽¹⁾	800	mW	
R _{IO}	Insulation Resistance at T _S , V_{IO} = 500 V ⁽¹⁾	> 10 ⁹	Ω	

Note:

1. Safety limit values - maximum values allowed in the event of a failure.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Value	Unit
TOTAL DEVIC	E		
T _{STG}	Storage Temperature	-40 to +125	°C
T _{OPR}	Operating Temperature	-40 to +100	°C
TJ	Junction Temperature	-40 to +125	°C
T _{SOL}	Lead Solder Temperature	260 for 10 seconds	°C
	Total Device Power Dissipation @ T _A = 25°C	270	mW
PD	Derate Above 25°C	2.94	mW/°C
EMITTER			
I _F	DC/Average Forward Input Current	60	mA
V _R	Reverse Input Voltage	3	V
Р	LED Power Dissipation @ $T_A = 25^{\circ}C$	120	mW
PD	Derate Above 25°C	1.41	mW/°C
DETECTOR			
۱ _C	Continuous Collector Current	150	mA
V _{CEO}	Collector-Emitter Voltage MOC8021M	50	V
	MOC8050M	80	V
Р	Detector Power Dissipation @ $T_A = 25^{\circ}C$	150	mW
PD	Derate Above 25°C	1.76	mW/°C

Electrical Characteristics

 T_A = 25°C Unless otherwise specified.

Individual Component Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
EMITTER						
V _F	Input Forward Voltage	I _F = 10 mA		1.18	2.00	V
I _R	Reverse Leakage Current	V _R = 3.0 V		0.001	10	μA
DETECTO	R	•				
	Collector-Emitter Breakdown Voltage					
BV _{CEO}	MOC8021M	I _C = 1.0 mA, I _F = 0	50	100		V
MOC8050M			80	100		V
BV _{ECO}	Emitter-Collector Breakdown Voltage	I _E = 100 μA, I _F = 0	5	10		V
I _{CEO}	Collector-Emitter Dark Current	V _{CE} = 60 V, I _F = 0			1	μA
C _{CE}	Capacitance	V _{CE} = 0 V, f = 1 MHz		8		pF

Transfer Characteristics

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
DC CHARA	CTERISTICS					
	Current Transfer Ratio, Collector to Emitter					
CTR	MOC8021M	$I_{\rm F} = 10 \text{ mA}, V_{\rm CE} = 5 \text{ V}$	1,000			%
MOC8050M		I _F = 10 mA, V _{CE} = 1.5 V	500			%
AC CHARA	CTERISTICS				•	
t _{on}	Turn-on Time	$I_{F} = 5 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_{L} = 100 \Omega$		8.5		μs
t _{off}	Turn-off Time	$I_{F} = 5 \text{ mA}, V_{CC} = 10 \text{ V},$ $R_{L} = 100 \Omega$		95		μs

Isolation Characteristics

Symbol	Characteristic	Test Conditions	Min.	Тур.	Max.	Unit
V _{ISO}	Input-Output Isolation Voltage	t = 1 Minute	4170			VAC _{RMS}
C _{ISO}	Isolation Capacitance	V _{I-O} = 0 V, f = 1 MHz		0.2		pF
R _{ISO}	Isolation Resistance	V _{I-O} = ±500 VDC, T _A = 25°C	10 ¹¹			Ω

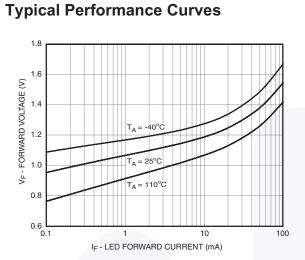


Figure 3. LED Forward Voltage vs. Forward Current

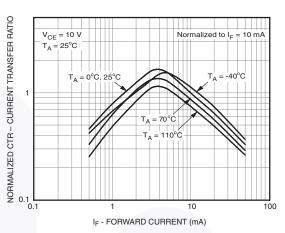


Figure 4. Normalized CTR vs. Forward Current

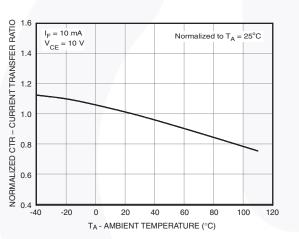
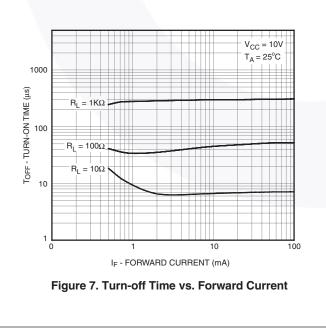


Figure 5. Normalized CTR vs. Ambient Temperature



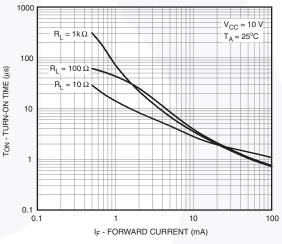
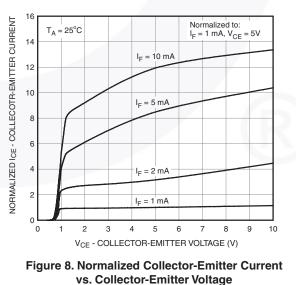
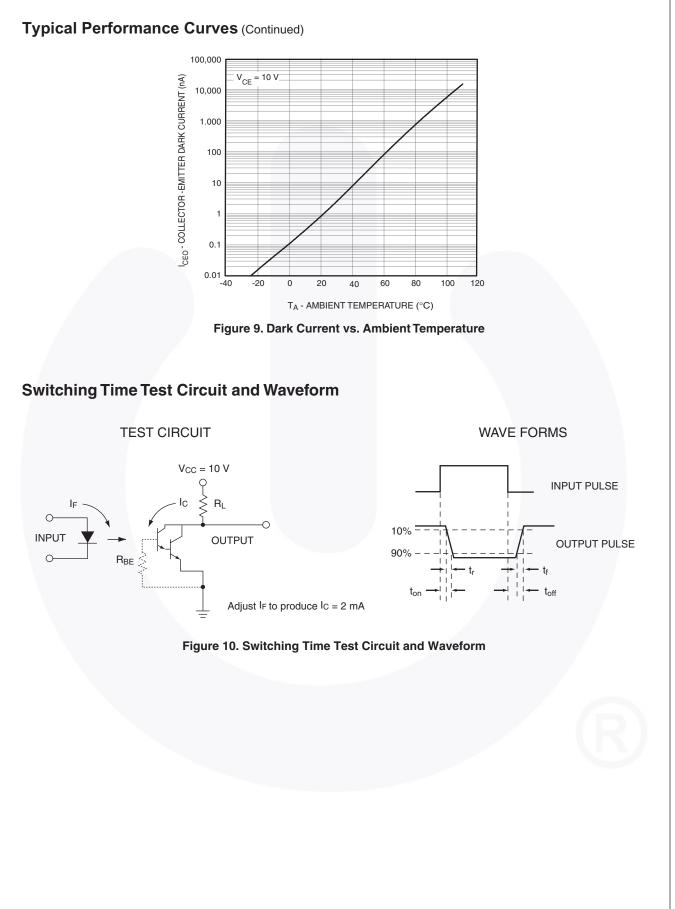
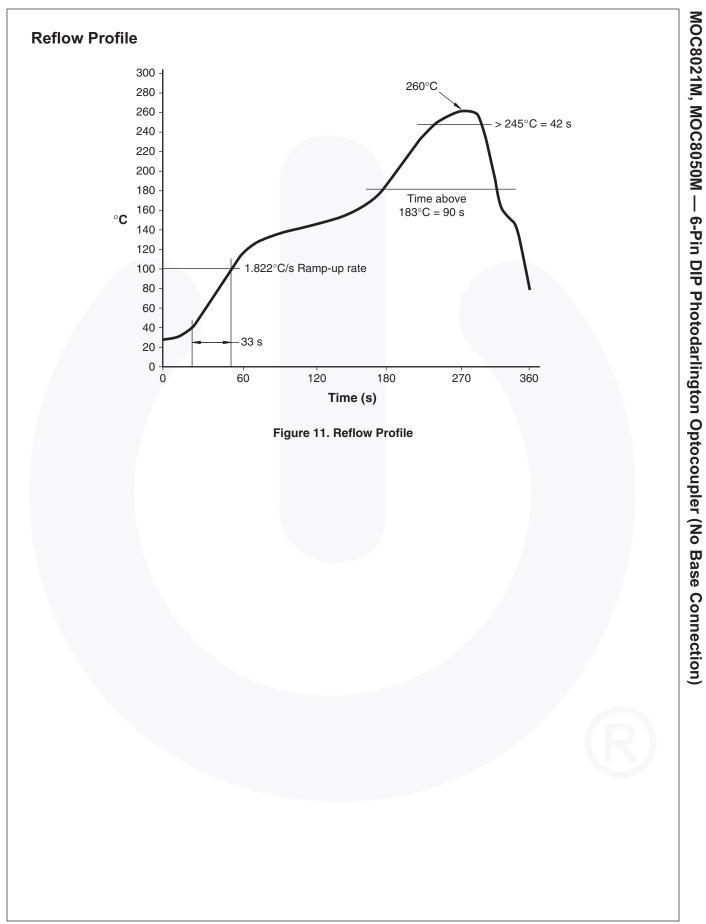


Figure 6. Turn-on Time vs. Forward Current



©2000 Fairchild Semiconductor Corporation MOC8021M, MOC8050M Rev. 3.2





Ordering Information

Part Number	Package	Packing Method
MOC8021M	DIP 6-Pin	Tube (50 Units)
MOC8021SM	SMT 6-Pin (Lead Bend)	Tube (50 Units)
MOC8021SR2M	SMT 6-Pin (Lead Bend)	Tape and Reel (1000 Units)
MOC8021VM	DIP 6-Pin, DIN EN/IEC60747-5-5 Option	Tube (50 Units)
MOC8021SVM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tube (50 Units)
MOC8021SR2VM	SMT 6-Pin (Lead Bend), DIN EN/IEC60747-5-5 Option	Tape and Reel (1000 Units)
MOC8021TVM	DIP 6-Pin, 0.4" Lead Spacing, DIN EN/IEC60747-5-5 Option	Tube (50 Units)

Note:

2. The product orderable part number system listed in this table also applies to the MOC8050M device.

Marking Information

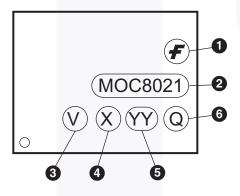


Figure 12. Top Mark

Table 1. Top Mark Definitions

1	Fairchild Logo	
2	Device Number	
3	DIN EN/IEC60747-5-5 Option (only appears on component ordered with this option)	
4	One-Digit Year Code, e.g., "5"	
5	Digit Work Week, Ranging from "01" to "53"	
6	Assembly Package Code	











NOTES:

- A) NO STANDARD APPLIES TO THIS PACKAGE.
- B) ALL DIMENSIONS ARE IN MILLIMETERS.
- C) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSION
- D) DRAWING FILENAME AND REVSION: MKT-N06Drev4





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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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